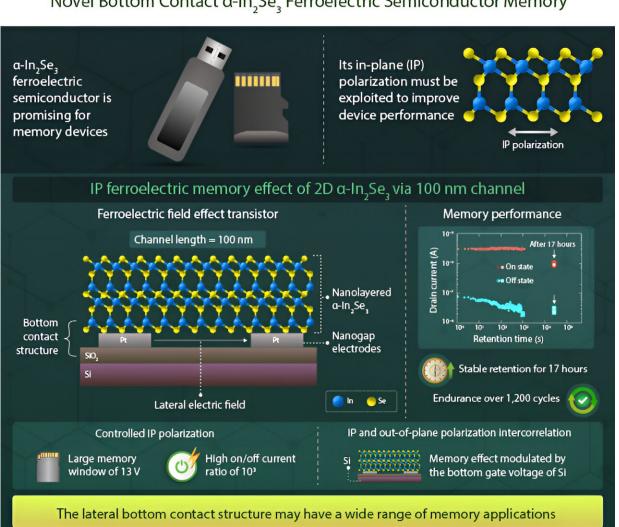
Novel lateral data storage: Two-dimensional ferroelectric semiconductor memory

August 16 2023



Novel Bottom Contact α -In₂Se₃ Ferroelectric Semiconductor Memory

Bottom Contact 100 nm Channel-Length a-In₂Se₃ In-Plane Ferroelectric Memory Miao et al. (2023) | Advanced Science | 10.1002/advs.202303032 東京工業大学 Talyo Instante of Technology



The lateral bottom contact structure may have a wide range of memory applications. Credit: Tokyo Tech

Traditional memory technologies face limitations in terms of speed, scalability, and power consumption, making them unsuitable for future data-intensive applications. Ferroelectric memory has garnered immense interest in recent years due to its potential for non-volatile storage, enabling data retention even when the power is turned off. The development of two-dimensional (2D) van der Waals material α -In₂Se₃ has also opened new opportunities for advancing memory technologies.

Interestingly, ferroelectric memory takes a giant step forward by incorporating the remarkable properties of α -In₂Se₃. It is renowned for <u>high carrier mobility</u>, tunable bandgap, and strong ferroelectric properties at the <u>atomic level</u>, making it ideal for high-speed memory applications.

However, the scope of research is limited by the lack of lateral α -In₂Se₃ devices that demonstrate in-plane (IP) polarization-controlled electrical characteristics. When fabricating bottom-contact ferroelectric field-effect transistors by 2D material exfoliation, wide electrode width is preferred to improve the overall yield.

However, achieving nanoscale channel lengths for the nanogap electrodes becomes challenging when simultaneously employing wide electrode widths, mainly due to the substantial ratio between the electrode width and channel length.

Recently, a team of researchers led by Professor Yutaka Majima from Tokyo Institute of Technology (Tokyo Tech) proposed a new concept of bottom contact structure at the nano level to solve this problem. They



have designed a ferroelectric semiconductor memory device with a twoterminal nanogap-structured bottom contact by leveraging the IP polarization flipping of α -In₂Se₃. Their work is published in *Advanced Science*.

Distinct from previous devices, α -In₂Se₃ is exfoliated on electrodes as the bottom contact in the present design. The IP polarization can be reversed by applying a drain voltage via a channel with a relatively narrow length of 100 nm. This lateral channel design allows for higher memory density, enabling the integration of many memory cells on a single chip.

Furthermore, the lateral memory configuration employed in the proposed technology enables seamless integration with existing semiconductor device fabrication techniques, facilitating a smooth transition from current memory technologies to non-volatile ferroelectric memory.

The researchers found that the α -In₂Se₃ ferroelectric memory exhibits typical resistive switching, a high on/off ratio of over 10^3 , a large memory window of 13 V, good retention for 17 hours, and endurance for 1,200 cycles. This will pave the way for non-volatile <u>ferroelectric</u> memory. Notably, massive integration becomes promising with a bottom contact structure, considering the simplified construction of next-generation electronics.

"Our ferroelectric semiconductor memory cultivates the IP polarization α -In₂Se₃ from a 100 nm bottom contact design, representing a significant leap forward in memory technology," says Prof. Majima. "We believe that this design will pave the way in which data is stored and accessed and open up exciting opportunities for various applications, including <u>artificial intelligence</u>, edge computing, and Internet of Things devices."



More information: Shurong Miao et al, Bottom Contact 100 nm Channel-Length α-In2Se3 In-Plane Ferroelectric Memory, *Advanced Science* (2023). DOI: 10.1002/advs.202303032

Provided by Tokyo Institute of Technology

Citation: Novel lateral data storage: Two-dimensional ferroelectric semiconductor memory (2023, August 16) retrieved 9 May 2024 from <u>https://techxplore.com/news/2023-08-lateral-storage-two-dimensional-ferroelectric-semiconductor.html</u>

This document is subject to copyright. Apart from any fair dealing for the purpose of private study or research, no part may be reproduced without the written permission. The content is provided for information purposes only.